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## 10550853 **Application Number** 2005-09-22 Filing Date INFORMATION DISCLOSURE MEUNIER-BEILLARD, PHILIPPE First Named Inventor STATEMENT BY APPLICANT 2823 Art Unit ( Not for submission under 37 CFR 1.99) NGUYEN, KHIEM D **Examiner Name** Attorney Docket Number NL03 0357 US1

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Examiner Initial*	Cite No	Patent Number	Kind Code <sup>1</sup>	lssue Date		Name of Patentee or Applicant of cited Document		Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear		ant
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/Khiem Nguyen/

04/12/2009

## INFORMATION DISCLOSURE STATEMENT BY APPLICANT

( Not for submission under 37 CFR 1.99)

Application Number		10550853		
Filing Date		2005-09-22		
First Named Inventor MEUN		NIER-BEILLARD, PHILIPPE		
Art Unit		2823		
Examiner Name NGUY		YEN, KHIEM D		
Attorney Docket Number		NL03 0357 US1		

Examiner Initials*	Cite No	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the it (book, magazine, journal, serial, symposium, catalog, etc), date, pages(s), volume-issue number(s), publisher, city and/or country where published.							
/K.N/	1	AGNELLO, P.D., ET AL; "HEAVY ARSENIC DOPING OF SILICON GRO'CHEMICAL VAPOR DEPOSITION AT LOW TEMPERATURES"; APPL. FPAGES 454 - 456							
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